TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type (π-MOSV)

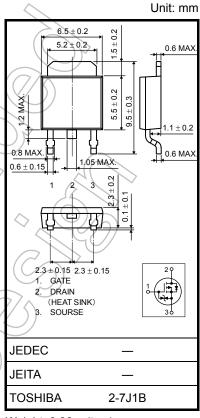
2SJ610

Switching Regulator, DC/DC Converter and Motor Drive Applications

- Low drain-source ON-resistance: R_{DS} (ON) = 1.85 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 18 S (typ.)
- Low leakage current: $I_{DSS} = -100 \,\mu\text{A} \,(V_{DS} = -250 \,\text{V})$
- Enhancement mode: $V_{th} = -1.5$ to -3.5 V ($V_{DS} = 10$ V, $I_{D} = 1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-250	(\sqrt{y})	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	-250	V	
Gate-source voltage	Gate-source voltage		±20	V	
	DC (Note 1)	ΙD	-2.0	A	
Drain current	Pulse (t = 1 ms) (Note 1)	I _{DP}	-4.0		
Drain power dissipati	on	P _D	20	/W	
Single-pulse avalanche energy (Note 2)		E _{AS}	180	mJ	
Avalanche current		I _{AR} –2.0		Α	
Repetitive avalanche energy (Note 3)		EAR	2.0	mJ	
Channel temperature		T _{ch}	150	7,c	
Storage temperature range		√T _{stg}	-55 to 150	°C	



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	6.25	°C/W
Thermal resistance, channel to ambient	Rth (ch-a)	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = –50 V, T_{Ch} = 25°C (initial), L = 75 mH, I_{AR} = –2.0 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

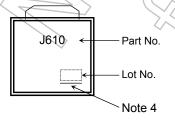
Electrical Characteristics (Ta = 25°C)

Char	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain cutoff curre	ent	I _{DSS}	V _{DS} = -250 V, V _{GS} = 0 V	_	_	-100	μА
Drain-source bre	akdown voltage	V (BR) DSS	I _D = -10 mA, V _{GS} = 0 V	-250	_	_	V
Gate threshold vo	oltage	V _{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-1.5	_	-3.5	V
Drain-source ON	-resistance	R _{DS (ON)}	$V_{GS} = -10 \text{ V}, I_D = -1.0 \text{ A}$	1	1.85	2.55	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -1.0 \text{ A}$	0.5	1.8	_	S
Input capacitance	e	C _{iss}		()	381	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	52	_	pF
Output capacitance		C _{oss}		_	157		
Switching time	Rise time	t _r	10 V	_	5	4	
	Turn-on time	t _{on}	V _{GS} 0 V R _L = 100 Ω	-	20	<u> </u>	no
	Fall time	t _f	V _{DD} ≈ 100 V	7	56	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{w} = 10 \mu s$	2)	36		
Total gate charge Q _g		Qg	Von x 200 V Von - 10 V) —	24	_	
Gate-source charge Qgs		Qgs	$V_{DD} \approx -200 \text{ V}, V_{GS} = -10 \text{ V},$ $I_D = -2.0 \text{ A}$	_	11	_	nC
Gate-drain charg	е	Qgd	10- 4.0 M	_	13	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

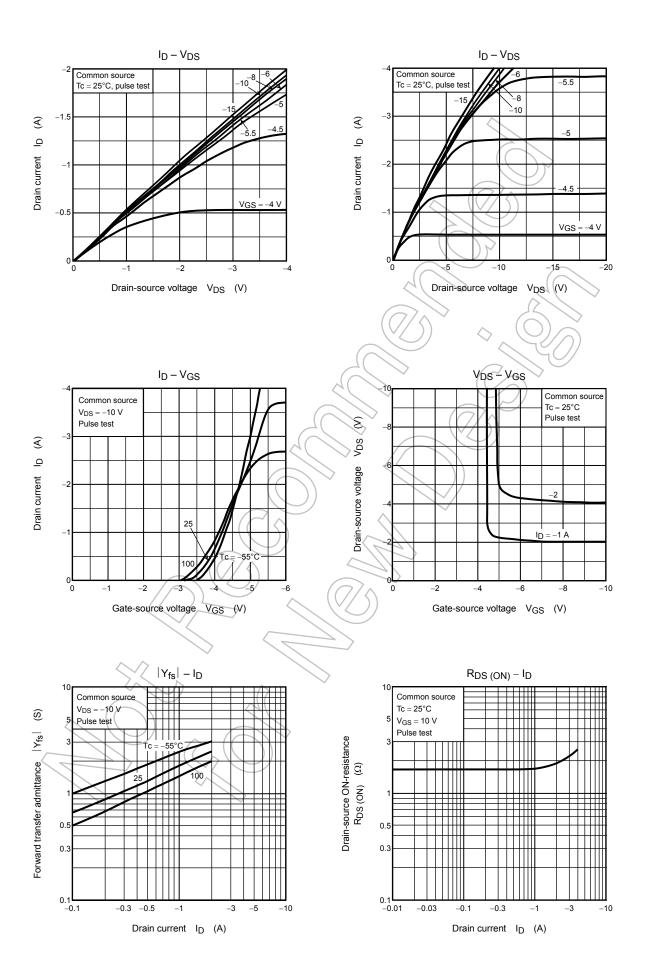
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1))) I _{DR}		_	_	-2.0	Α
Pulse drain reverse current (Note 1)	I _{DRP}	((//)) -	_	_	-4.0	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = -2.0 A, V _{GS} = 0 V	_	_	2.0	V
Reverse recovery time	t _{ri}	$I_{DR} = -2.0 \text{ A}, V_{GS} = 0 \text{ V},$	_	120	_	ns
Reverse recovery charge	Qrr	dI _{DR} /dt = 100 A/μs	_	540	_	nC

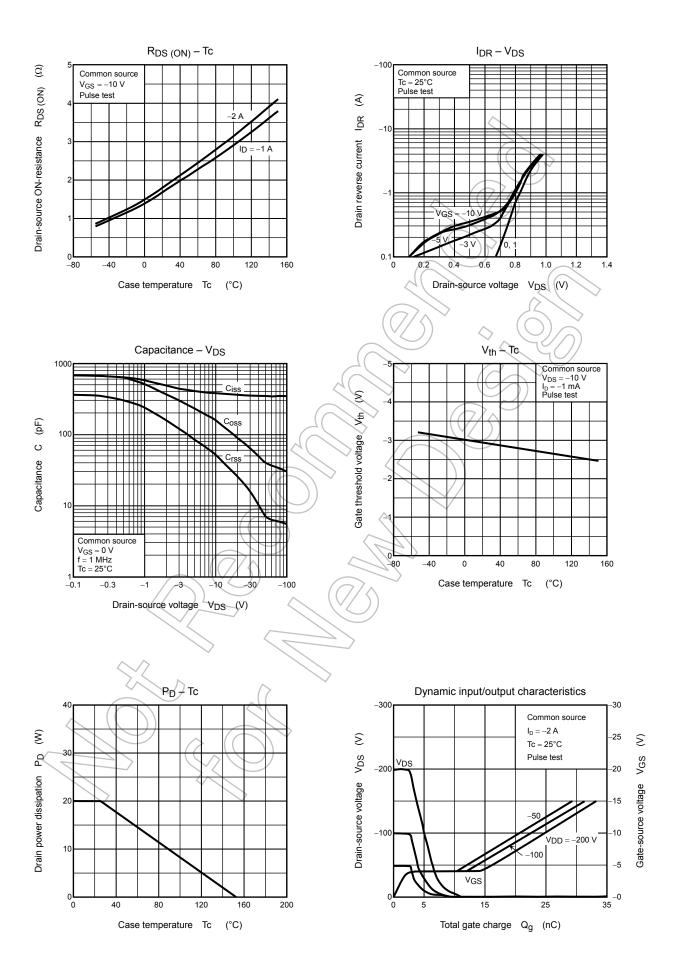
Marking

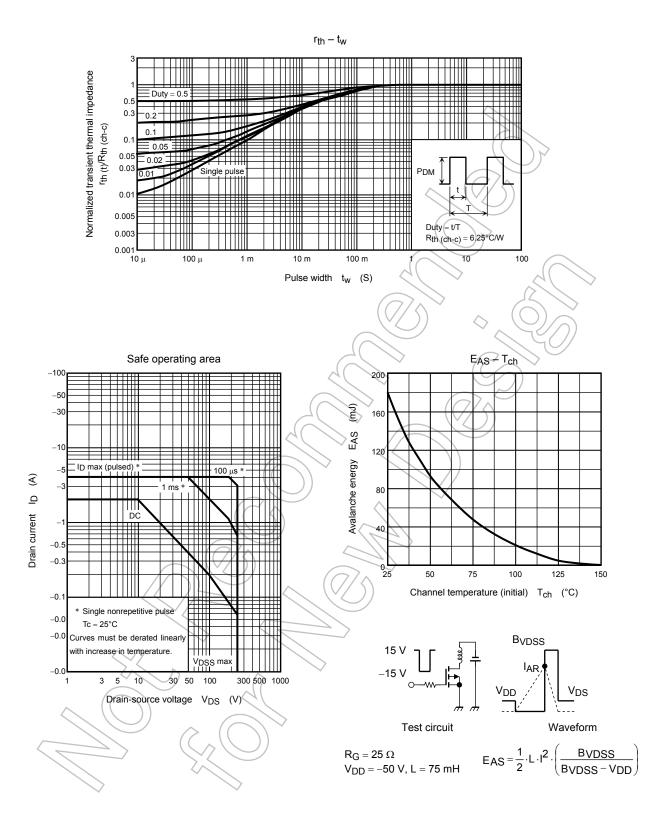


Note 4 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.







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